ESD protection.

VGA Port Protector

Features

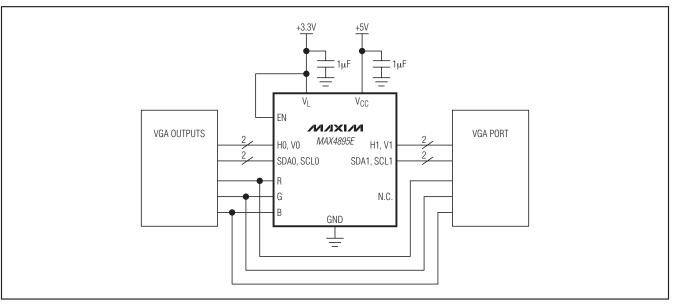
- ESD Protection on H1, V1, SDA1, SCL1, R, G, and B ±15kV—Human Body Model ±8kV—IEC 61000-4-2, Contact Discharge
- Low Quiescent Current, $I_Q \le 5\mu A$ (max)
- Low 3pF (max) Capacitance (R, G, B Ports)
- DDC Level-Shifting Protection and Isolation
- Horizontal Sync, Vertical Sync Level Shifting/ Buffering
- Input Compatible with VL
- Output Full +5.0V TTL Compatible (per VESA)
- ±10mA Drive on Each H, V Terminal
- Space-Saving, Lead-Free, 16-Pin (3mm x 3mm)
 TQFN Package

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX4895EETE+	-40°C to +85°C	16 TQFN-EP*

+Denotes a lead(Pb)-free/RoHS-compliant package. *EP = Exposed pad.

Typical Operating Circuit



_ Maxim Integrated Products 1

MAX4895

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

Applications

General Description

The MAX4895E integrates level-translating buffers and

The MAX4895E has H, V (horizontal, vertical) translat-

ing buffers that take low-level CMOS inputs from the graphics outputs to meet full +5.0V, TTL-compatible

outputs. Each output can drive ±10mA and meet the VESA® specification. In addition, the device takes the

+5.0V, direct digital control (DDC) signals and translates them to the lower level required by the graphics

device. This level is set by the user by connecting VL to

the graphics output supply. The R, G, B terminals protect the graphics output pins against electrostatic dis-

charge (ESD) events. All seven outputs have high-level

The MAX4895E is specified over the extended -40°C to

+85°C temperature range, and is available in a 16-pin,

features R, G, B port protection for VGA signals.

Graphics Cards

Desktops

Servers

Notebook Computers

3mm x 3mm TQFN package.

VESA is a registered service mark of Video Electronics Standards Association Corporation.

ABSOLUTE MAXIMUM RATINGS

(All voltages referenced to GND.)

V _{CC}	0.3V to +6.0V
V _L	
R, G, B, H1, V1, SCL1, SDA1	0.3V to $+(V_{CC} + 0.3V)$
EN, H0, V0, SCL0, SDA0	0.3V to $+(V_{L} + 0.3V)$
Continuous Current through SDA_,	SCL±30mÅ
Continuous Short-Circuit Current H1	I, V1±20mA

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a fourlayer board. For detailed information on package thermal considerations, refer to <u>www.maxim-ic.com/thermal-tutorial</u>.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = +4.5V to +5.5V, V_L = +2.0V to V_{CC}, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at V_{CC} = +5.0V, V_L = +3.3V, and T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
SUPPLY OPERATION	·		•			
Supply Voltage	V _{CC}		4.5		5.5	V
Logic Supply Voltage	VL	$V_L \leq V_{CC}$	2	3.3	5.5	V
V _{CC} Supply Current	Icc	V_{HO} , $V_{VO} = 0V$, $V_{EN} = V_L$		0.5	5.0	μA
VL Supply Current	١L	V_{H0} , $V_{V0} = 0V$, $V_{EN} = V_L$ (no load)		0.5	5.0	μA
RGB CHANNELS						
R, G, B Capacitance	COUT	$f = 1MHz, V_{R,G,B} = 1V_{P-P}$ (Note 3)		2.2		pF
R, G, B Leakage		$V_{CC} = +5.5V$	-1		+1	μA
H_, V_, EN CHANNELS	·	•	·			
Input Threshold Low	VIL	$V_{L} = +3.0V$			0.8	V
Input Threshold High	VIH	$V_{L} = +3.6V$	2.0			V
Input Hysteresis	VHYST			100		mV
Input Leakage Current	ILEAK	$V_L = +3.3V, V_{CC} = +5.5V$	-1		+1	μA
Output-Voltage Low	Vol	$I_{OUT} = 10$ mA sink, $V_{CC} = +4.5V$			0.8	V
Output-Voltage High	V _{OH}	$I_{OUT} = 10$ mA source, $V_{CC} = +4.5V$	2.4			V
Propagation Delay	t _{PD}	$ \begin{array}{l} {\sf R}_L = 2.2 {\sf k} \Omega, {\sf C}_L = 10 {\sf p} {\sf F}, {\sf V}_{OL} = +0.8 {\sf V}, \\ {\sf V}_{OH} = +2.4 {\sf V} \end{array} $		15		ns
Enable Time	ton, toff			15		ns
SDA_, SCL_ (DDC) CHANNELS	3					
On-Resistance, SDA, SCL	R _{ON}	$V_{CC} = +5.5V$, $I_{SDA, SCL} = \pm 10mA$, $V_{SDA, SCL} = +0.5V$		20	55	Ω
Leakage Current, SDA, SCL	ILEAK	$V_L = 0V$	-1		+1	μA

ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} = +4.5V to +5.5V, V_L = +2.0V to V_{CC}, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at V_{CC} = +5.0V, V_L = +3.3V, and T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
ESD PROTECTION						
SDA1, SCL1, H1, V1, R, G, B		Human Body Model (Note 4)		±15		kV
SDA1, SCL1, H1, V1, R, G, B		IEC 61000-4-2 Contact		±8		kV

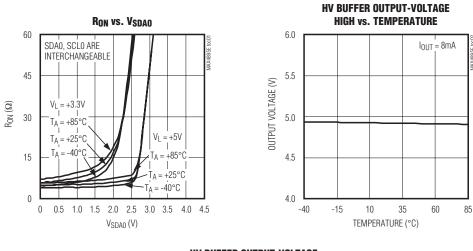
Note 2: All devices are 100% production tested at $T_A = +25$ °C. All temperature limits are guaranteed by design.

Note 3: Guaranteed by design, not production tested.

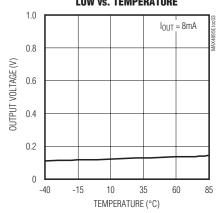
Note 4: Tested terminals to GND; 1μ F bypass capacitors on V_{CC} and V_L.

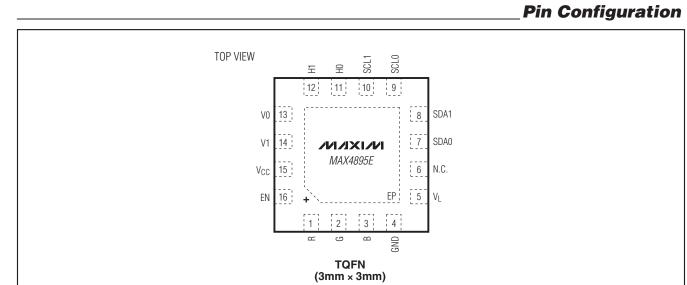
(V_{CC} = +5.0V, V_L = +3.3V, and T_A = +25°C, unless otherwise noted.)

Typical Operating Characteristics









Pin Description

PIN	NAME	FUNCTION
1	R	High-ESD Protection Diodes for RGB Signals
2	G	High-ESD Protection Diodes for RGB Signals
3	В	High-ESD Protection Diodes for RGB Signals
4	GND	Ground
5	VL	Supply Voltage, +2.0V to V _{CC} . Bypass V _L to GND with a 1μ F ceramic capacitor.
6	N.C.	No Connection. Leave unconnected.
7	SDA0	SDA I/O. SDA0 referenced to VL.
8	SDA1	SDA I/O. SDA1 referenced to V _{CC} .
9	SCL0	SCL I/O. SCL0 referenced to VL.
10	SCL1	SCL I/O. SCL1 referenced to V _{CC} .
11	HO	Horizontal Sync Input
12	H1	Horizontal Sync Output
13	V0	Vertical Sync Input
14	V1	Vertical Sync Output
15	V _{CC}	Power-Supply Voltage, +4.5V to +5.5V. Bypass V_{CC} to GND with a 1µF ceramic capacitor.
16	EN	Enable for H1 and V1 Outputs
	EP	Exposed Pad. Connect EP to GND or leave unconnected. For enhanced thermal dissipation, connect EP to a copper area as large as possible. Do not use EP as a sole ground connection.

Power-Supply Decoupling

Bypass V_{CC} and V_L to ground with a 1μ F ceramic capacitor as close as possible to the device.

PCB Layout

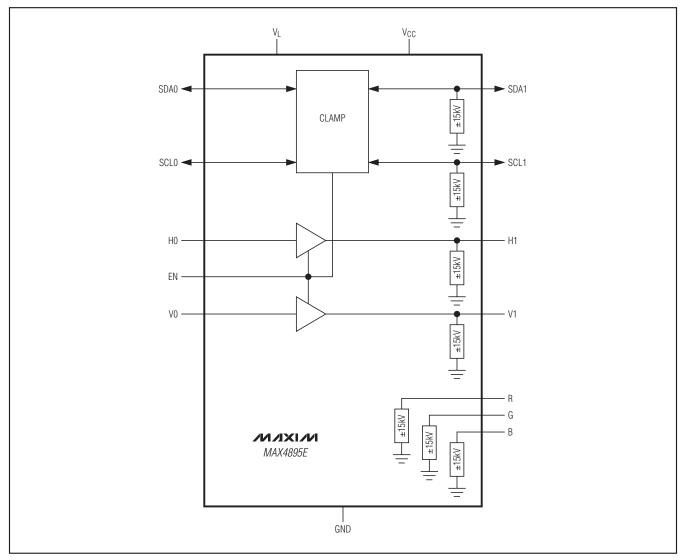
5

High-speed switches such as the MAX4895E require proper PCB layout for optimum performance. Ensure that impedance-controlled PCB traces for high-speed signals are matched in length and are as short as possible. Connect the exposed pad to a solid ground plane.

VGA Port Protector

_Functional Diagram

MAX4895E



Applications Information

The MAX4895E provides the level shifting necessary to drive two standard VGA ports from a graphics controller as low as +2.2V. Internal buffers drive the HSYNC and VSYNC signals to VGA standard TTL levels. The DDC switch provides level shifting by clamping signals to a diode drop less than V_L (see the *Typical Operating Circuit*). Connect V_L to +3.3V for normal operation.

_Detailed Description

The MAX4895E integrates level-translating buffers and features R, G, B port protection for VGA signals.

Horizontal and vertical synchronization (H0/V0) inputs feature level-shifting buffers to support low-voltage CMOS or standard TTL-compatible graphics controllers. The device meets ±10mA VESA drive requirements. The MAX4895E also features I²C level shifting using two nMOS devices. All outputs maintain ±15kV Human Body Model (HBM) and ±8kV Contact Discharge per IEC 61000-4-2 on seven terminals (SDA1, SCL1, H1, V1, R, G, B). The R, G, B pads protect the digital-to-analog converter (DAC) and are simply placed in parallel with the R, G, B outputs for the DAC and VGA socket.

Horizontal/Vertical Sync Level Shifter HSYNC/VSYNC are buffered to provide level shifting and drive capability to meet the VESA specification. Input logic levels (V_{IL}, V_{IH}) are connected to V_L (see the *Electrical Characteristics* table). The level-shifted outputs (H1 and V1) are pulled low when EN is driven low (see Table 1). Logic-level output (V_{OL}, V_{OH}) are +5.0V TTL compatible.

Table 1. HV Truth Table

EN	FUNCTION
1	HSYNC/VSYNC level shifting enabled
0	H1, V1 = 0

Table 2. DDC Truth Table

EN	FUNCTION
1	SDA0 to SDA1 SCL0 to SCL1
0	SDA1, SCL1, high impedance

Display Data Channel Switches

The MAX4895E incorporates two nMOS switches for I²C level shifting. The SDA, SCL terminals are voltage clamped to a diode drop less than the V_L voltage. Voltage clamping provides protection and compatibility with SDA, SCL signals and low-voltage ASICs. Supply +2.5V to +3.3V on V_L to provide voltage clamping for VESA I²C-compatible signals. The SDA, SCL switches are identical, and each switch can be used to route SDA or SCL signals.

RGB

There are three terminals for R, G, and B. The only function of these terminals is to provide high-level ESD protection to the RGB lines, while at the same time, keeping the capacitance on the RGB lines to a minimum. The R, G, B terminals are identical, and any of the three terminals can be used to protect red, green, or blue video signals.

ESD Protection

As with all Maxim devices, ESD-protection structures are incorporated on all terminals to protect against electrostatic discharges encountered during handling and assembly. Additionally, the MAX4895E is protected to ± 15 kV on the RGB terminals and outputs H1, V1, SDA1, and SCL1 by the Human Body Model (HBM). For optimum ESD performance, bypass V_{CC} to ground with a 1µF ceramic capacitor.

ESD protection can be tested in various ways. The R, G, B terminals and outputs H1, V1, SDA1, and SCL1 of the MAX4895E are characterized for protection to the following limits:

- ±15kV using the Human Body Model
- ±8kV IEC 61000-4-2 Contact Discharge

ESD Test Conditions

ESD performance depends on a variety of conditions. Contact Maxim for a reliability report documenting test setup, methodology, and results.

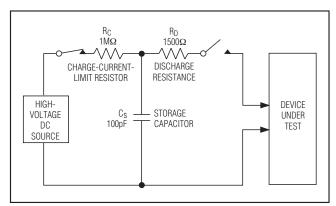


Figure 1a. Human Body ESD Test Model

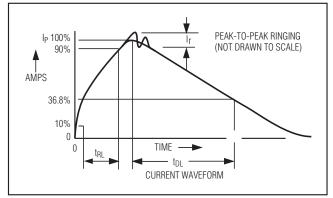


Figure 1b. Human Body Current Waveform

Human Body Model (HBM)

Figure 1a shows the Human Body Model, and Figure 1b shows the current waveform it generates when discharged into a low impedance. This model consists of a 100pF capacitor charged to the ESD voltage of interest that is then discharged into the test device through a $1.5 k\Omega$ resistor.

IEC 61000-4-2

The IEC 61000-4-2 standard covers ESD testing and performance of finished equipment. However, it does not specifically refer to integrated circuits. The MAX4895E assists in designing equipment to meet IEC 61000-4-2 without the need for additional ESD-protection components.

The major difference between tests done using the Human Body Model and IEC 61000-4-2 is higher peak current in IEC 61000-4-2 because series resistance is

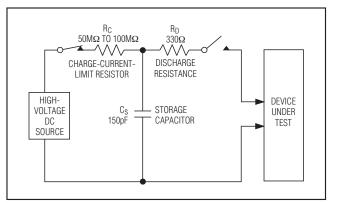


Figure 1c. IEC 61000-4-2 ESD Test Model

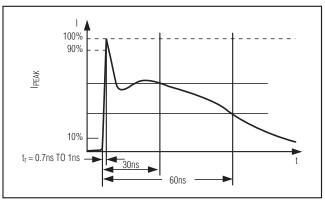


Figure 1d. IEC 61000-4-2 ESD Generator Current Waveform

lower in the IEC 61000-4-2 model. Hence, the ESD withstand voltage measured to IEC 61000-4-2 is generally lower than that measured using the Human Body Model. Figure 1c shows the IEC 61000-4-2 model, and Figure 1d shows the current waveform for IEC 61000-4-2 ESD Contact Discharge test.

Chip Information

PROCESS: BICMOS

Package Information

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	OUTLINE	LAND
TYPE	CODE	NO.	PATTERN NO.
16 TQFN-EP	T1633+4	<u>21-0136</u>	<u>90-0031</u>



7

MAX4895E

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	4/09	Initial release	—
1	6/10	Deleted the "Top Mark" column from the Ordering Information	1

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

_Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 408-737-7600

Revision History

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Analog Devices Inc.:

MAX4895EETE+ MAX4895EETE+T